

ACAR3705-S698



Features

- 4G/LTE full band coverage (700~960 MHz, 1710~2170 MHz, 2500~2700MHz)
- 2G/3G/GSM support
- Compact size
- Linear polarization

Applications

- IoT
- M2M
- 4G/LTE/3G/2G/GSM applications
- Telecommunications
- Networking
- Wireless modules
- Mobile devices
- Consumer electronics
- Broadband cellular connectivity
- Video and surveillance

Electrical Characteristics

Item	Spec	*	Comments		
Working Frequency Range	700~960 MHz / 1710 2500~2700		Covers 4G LTE		
VSWR	4.5 : 1 n	nax	Depends on the environment		
Peak Gain	1.07 / 4.03 / 3	3.76 dBi			
	700~960 MHz	55%			
Efficiency	1710~ 2170MHz	70%			
	2500~2700MHz	50%			
Polarization	Linea	r			
Impedance	50 Ω				
Terminations	Ag		Environmentally Friendly Pb Free		
Operating Temperature	-40°C ~ 8	35°C			
Storage Temperature	-40°C ~ 8	35°C			

^{*} Data collected per Table on standard evaluation board size 45×120 mm, and under the environmental conditions of $+40^{\circ}$ C and 0-95% relative humidity.



^{**} Actual Electrical value will depend on customer ground plane size

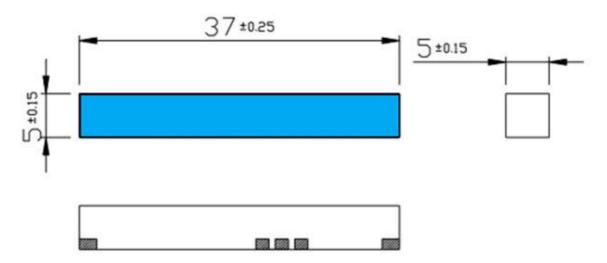


ACAR3705-S698



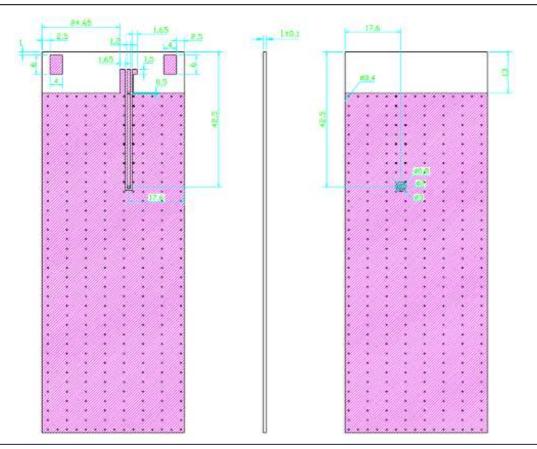
37.0 x 5.0 x 5.0 mm RoHS/RoHS II Compliant MSL = NA

Dimensions



Unit:mm

Evaluation Board and Dimensions





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ABRACON IS ISO9001-2015 CERTIFIED

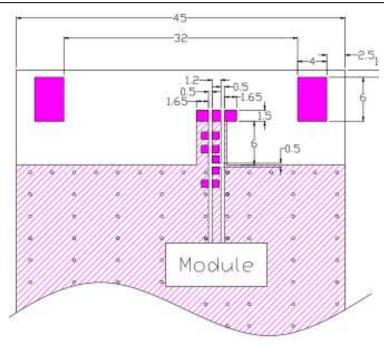


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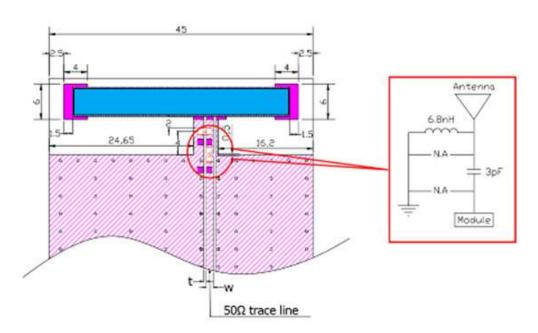
37.0 x 5.0 x 5.0 mm RoHS/RoHS II Compliant MSL = NA

Recommended Layout Dimensions



Unit: mm

Recommended Layout from Evaluation Board



T and w = Unique dimensioning according to your PCB design.

Unit: mm



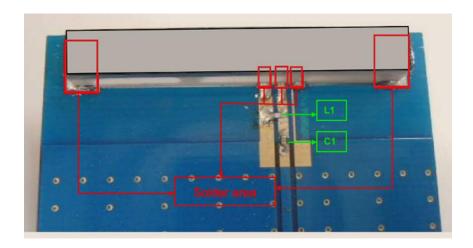


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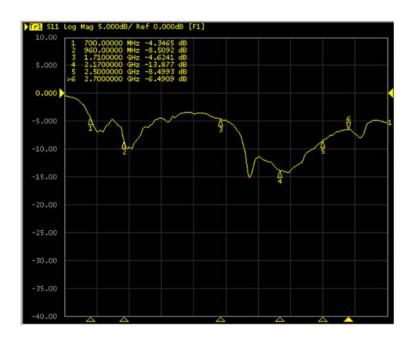
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Evaluation Board showing position of match components and solder pads



Circuit Symbol	Size	Description
L1	0402	6.8nH
C1	0402	3pF Capacitor

Antenna Response – Return Loss S11





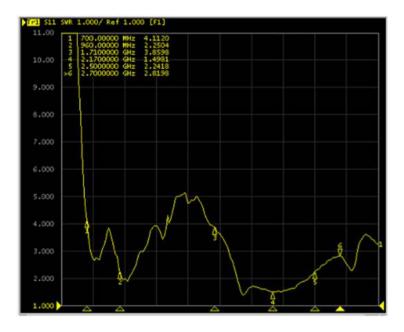


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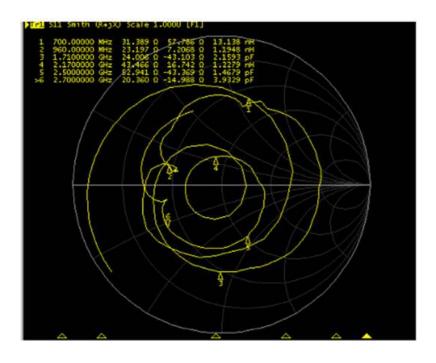


37.0 x 5.0 x 5.0 mm RoHS/RoHS II Compliant MSL = NA

Antenna SWR



Antenna Smith Chart







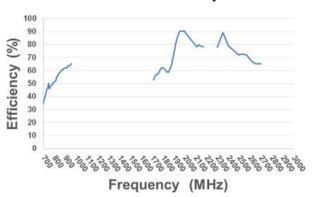
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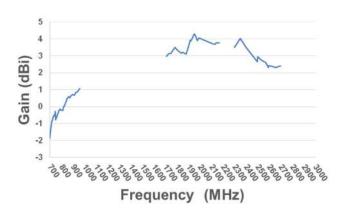
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Measurements on Standard Evaluation Board

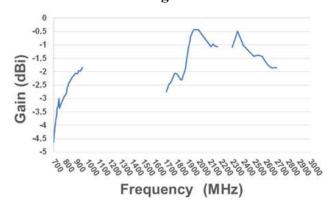
Antenna Efficiency



Peak Gain



Average Gain







ACAR3705-S698



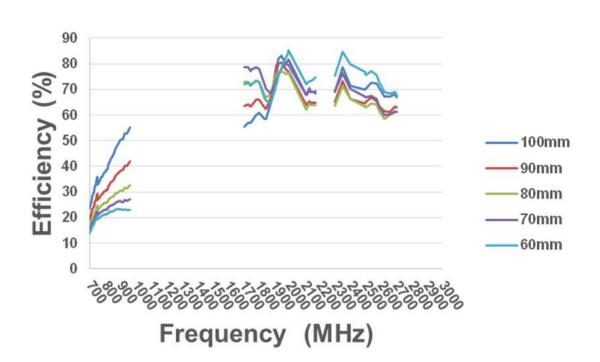
37.0 x 5.0 x 5.0 mm RoHS/RoHS II Compliant MSL = NA

Antenna Performance

Antenna Performance Summary on the 45 x 120 mm Evaluation Board									
Frequency Band (MHz)	700	824	960	1710	1850	1990	2170	2500	2700
Efficiency (%)	35.12	54.26	65.49	53.03	58.87	90.53	78.19	72.31	65.10
Average Gain (dBi)	-4.54	-2.57	-1.83	-2.75	-2.30	-0.43	-1.06	-1.40	-1.86
Peak Gain (dBi)	-1.80	0.016	1.07	2.97	3.21	4.03	3.76	2.96	2.38

Antenna Efficiency Versus Ground Plane Length

Reference Efficiency vs Ground Plane Length







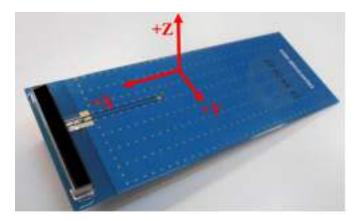
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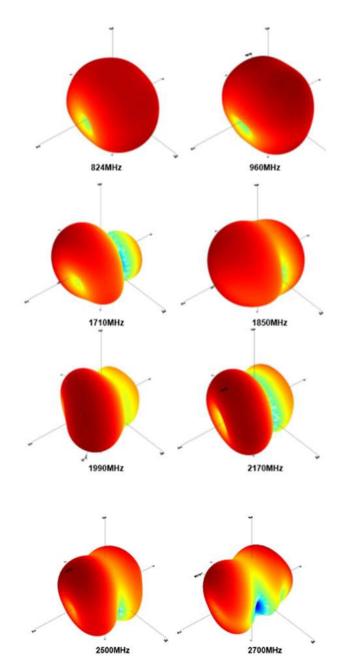
37.0 x 5.0 x 5.0 mm **RoHS/RoHS II Compliant** MSL = NA

Antenna 3D Radiation Patterns – Evaluation Board

Coordinates



Radiation patterns (3D)







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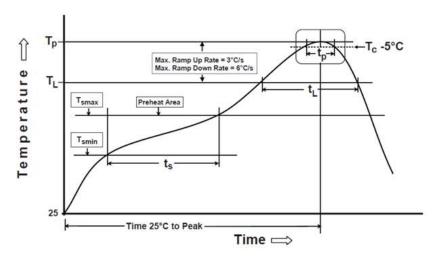


Reflow Soldering Standard Condition

ACAR3705-S698 can be assembled as per the Pb-free assembly given below.

Phase	Profile Features	Pb-Free Assembly (SnAgCu)		
	-Temperature Min (Tsmin)	150°C		
Preheat	-Temperature Max (Tsmax)	200°C		
	-Time (Tsmin to Tsmax)	60-120 seconds		
Ramp-Up	Avg Ramp-Up Rate (Tsmax to TP)	3°C /second(max)		
Reflow	-Temperature (TL)	217°C		
	-Total Time above TL (t L)	60-150 seconds		
Peak	-Temperature (TP)	260°C		
	-Time(tp)	20 - 30 second		
Ramp-Down	Rate	6°C / second max.		
Time from 25°C to Peak Temperature		8 minutes max.		
Composition of solder plate		96.5Sn/3Ag/0.5Cu		
Solder Paste Model		SHENMAO PF606-P26		

According to the Standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follow:



Note: All the temperature measurement points are on the component's top surface. If the applied temperature is over recommended, the component's surface will start to peel or damage.

Soldering with Iron:

Soldering iron temperature: 270±10 °C

Apply preheating at 120 C for 2-3 minutes and complete the soldering for each terminal within 3 seconds.

Note: If the applied temperature is over recommended or if the time exceeds the stated, the component's surface will start to peel or damage.





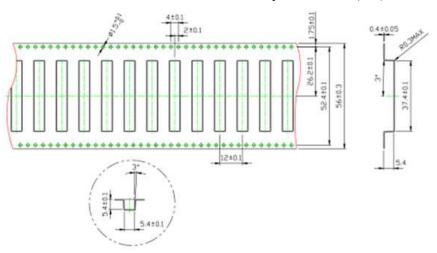
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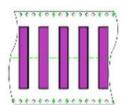


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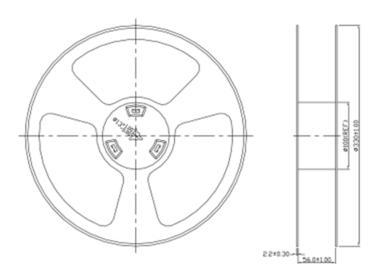
Packaging

Tape Dimensions (mm)





Reel Dimensions (mm)



- 1. Blister tape to IEC 286-3, polyester.
- 2. Pieces per tape /reel: 450pcs

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